

Title (en)  
MODULAR COOLING SYSTEM

Title (de)  
MODULARES KÜHLSYSTEM

Title (fr)  
SYSTÈME MODULAIRE DE REFROIDISSEMENT

Publication  
**EP 2344828 A4 20130731 (EN)**

Application  
**EP 09817092 A 20090930**

Priority  

- AU 2009001291 W 20090930
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Abstract (en)  
[origin: WO2010037164A1] A heat exchange unit (102) for use in a modular heat exchange system including at least one first heat exchanger (104) having a closed circuit for cooling fluid at least one air cooler (112) located upstream of the first heat exchanger, and at least one first fan arrangement (110) operable to cause air to pass through the at least one air cooler (112) and the at least one first heat exchanger (104), at least one channel providing cooling fluid interconnection between the first heat exchanger and, when in use in the modular heat exchange system, a heat exchanger in at least one other heat exchange unit.

IPC 8 full level  
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Citation (search report)  

- [Y] KR 20070072213 A 20070704 - LG ELECTRONICS INC [KR]
- [Y] US 2002078704 A1 20020627 - STICH JOHN L [US]
- [A] US 2006130517 A1 20060622 - MERKYS JUSTIN P [US], et al
- See also references of WO 2010037164A1

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

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**WO 2010037164 A1 20100408**; AU 2009299103 A1 20100408; AU 2009299103 B2 20120202; AU 2009299104 A1 20100408;  
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CN 102216722 B 20161019; EP 2344828 A1 20110720; EP 2344828 A4 20130731; EP 2344828 B1 20200513; EP 2344829 A1 20110720;  
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